

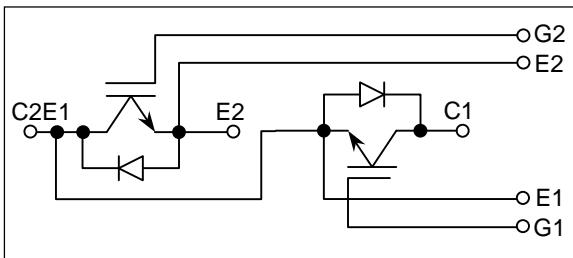
MBM200GR12A

[Rated 200A/1200V, Dual-pack type]

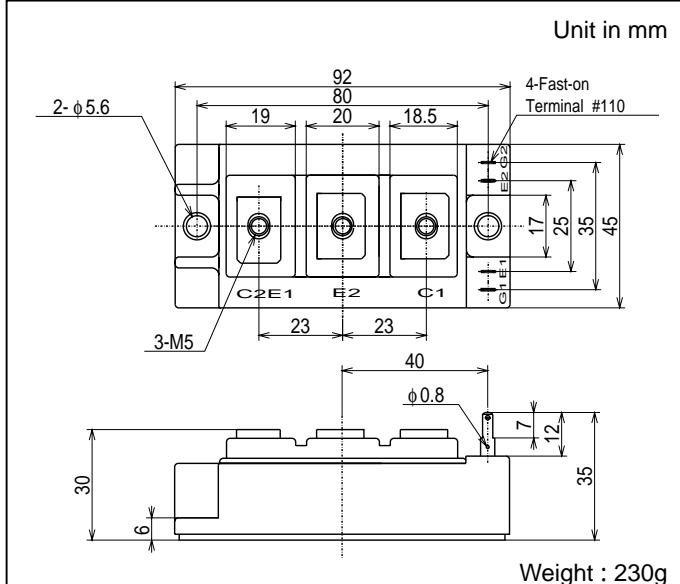
FEATURES

- Low saturation voltage and high speed.
- Low turn-OFF switching loss.
- Low noise due to built-in free-wheeling diode.
(Ultra Soft and Fast recovery Diode (USFD))
- High reliability structure.
- Isolated heat sink (terminals to base).

CIRCUIT DIAGRAM



OUTLINE DRAWING



ABSOLUTE MAXIMUM RATINGS ($T_C=25^\circ\text{C}$)

Item	Symbol	Unit	Value
Collector-Emitter Voltage	V_{CES}	V	1200
Gate-Emitter Voltage	V_{GES}	V	± 20
Collector Current	DC	A	200
1ms	I_{CP}		400
Forward Current	DC	A	200 *1
1ms	I_{FM}		400
Collector Power Dissipation	P_C	W	1250
Junction Temperature	T_j	$^\circ\text{C}$	-40 ~ +150
Storage Temperature	T_{stg}	$^\circ\text{C}$	-40 ~ +125
Isolation Voltage	V_{iso}	V_{RMS}	2500(AC 1 minute)
Screw Torque	Terminals	N·m	1.96 *2
Mounting			1.96 *3

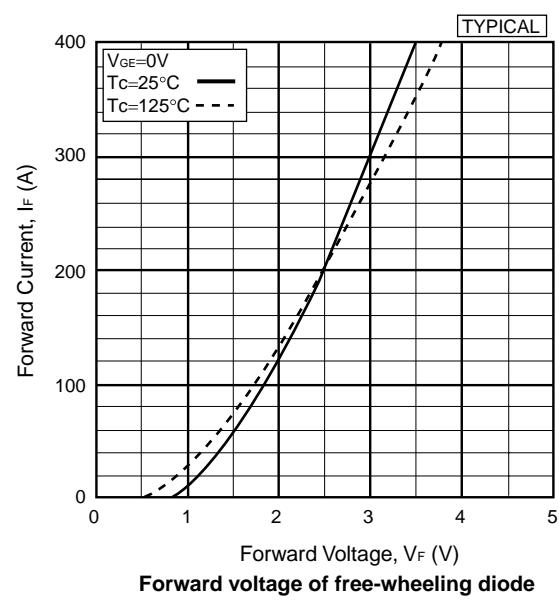
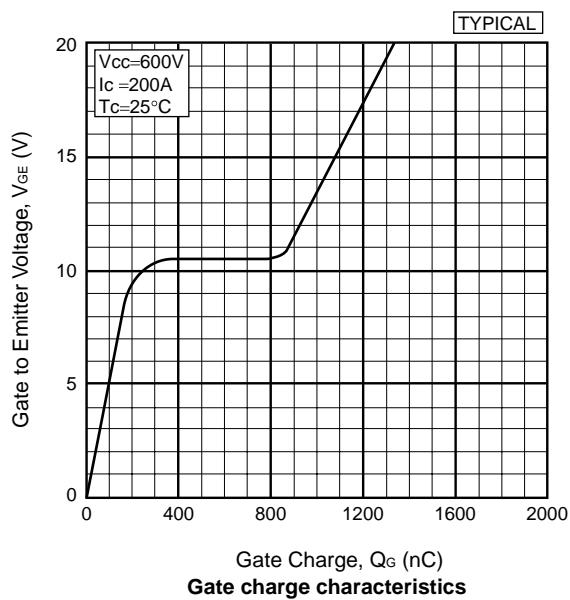
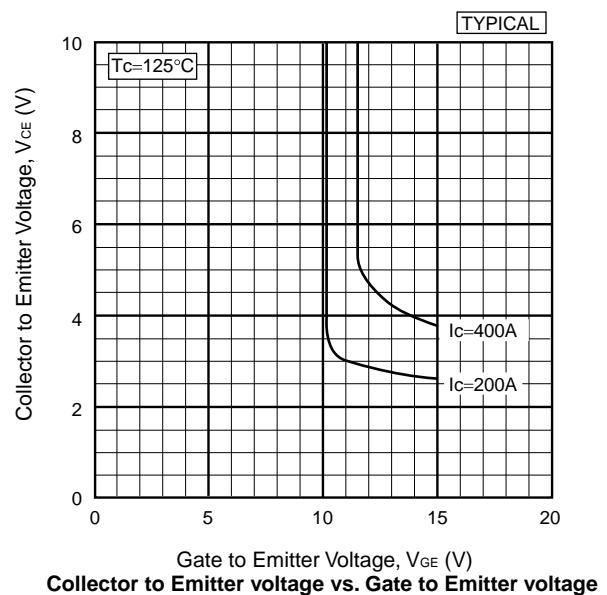
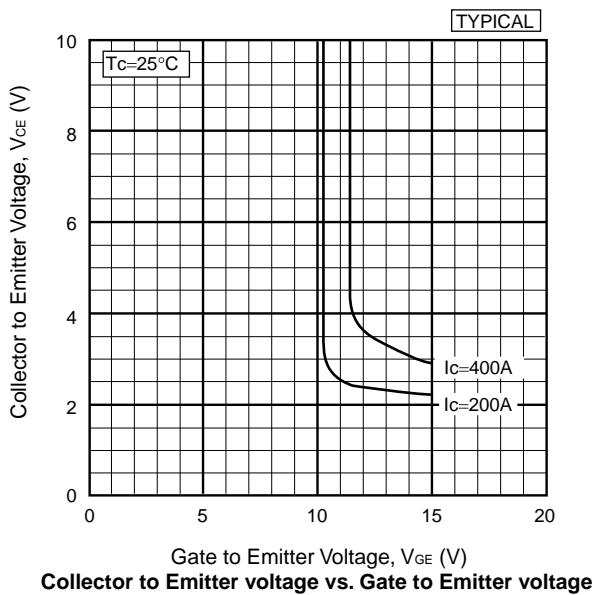
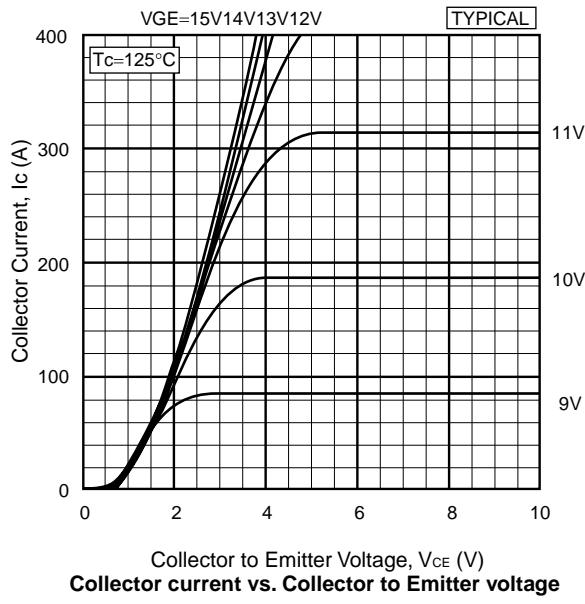
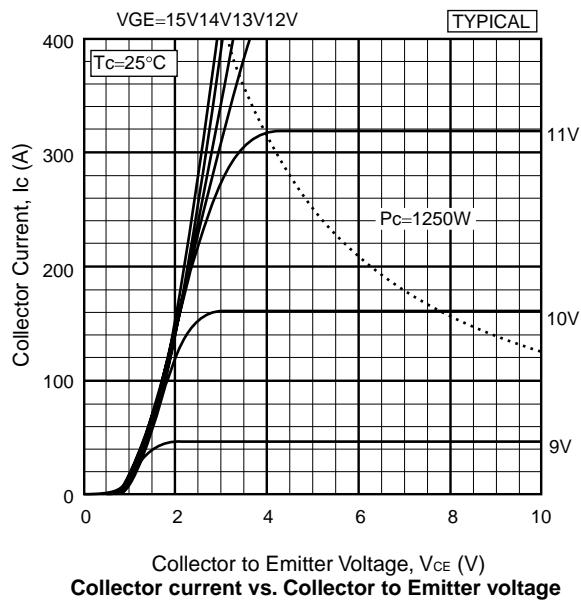
Notes: *1 : RMS current of diode ≤ 60 Arms

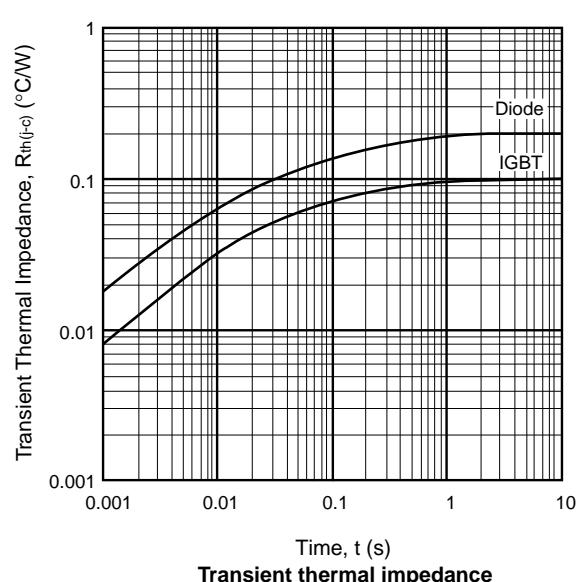
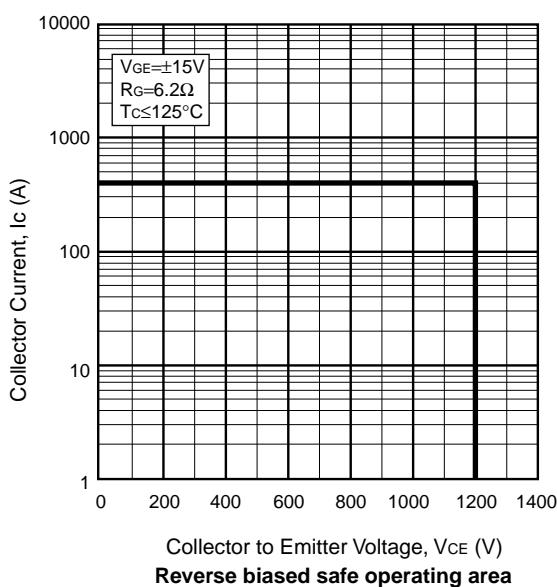
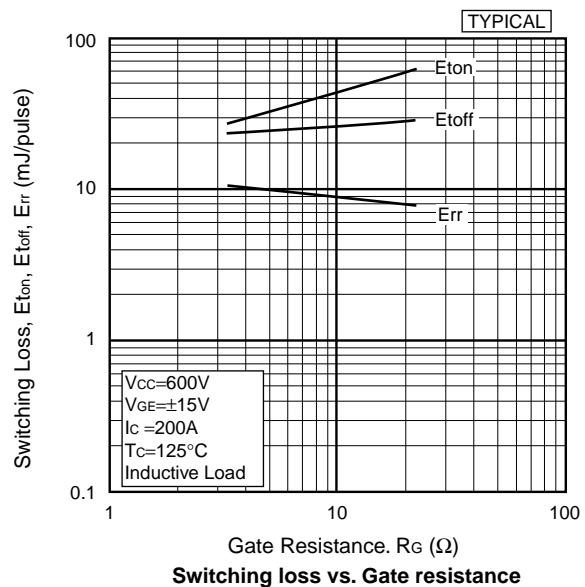
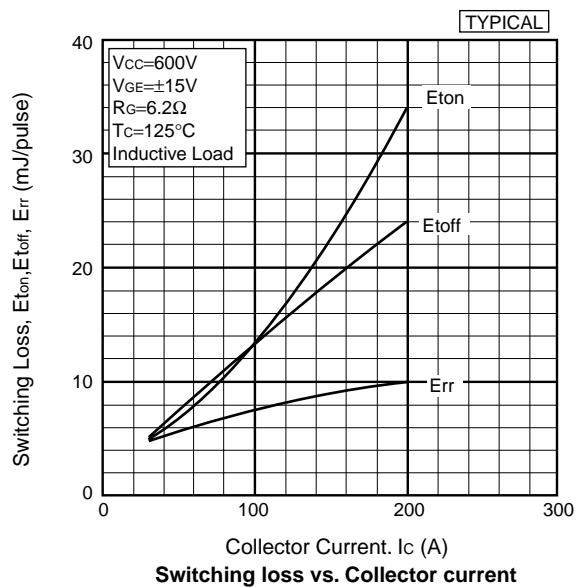
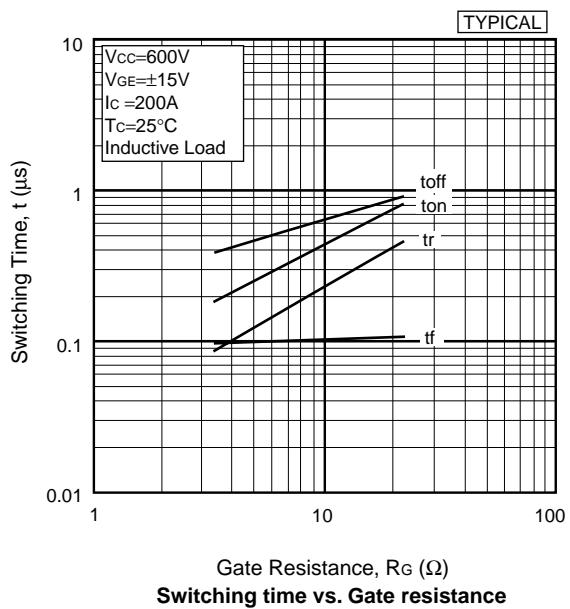
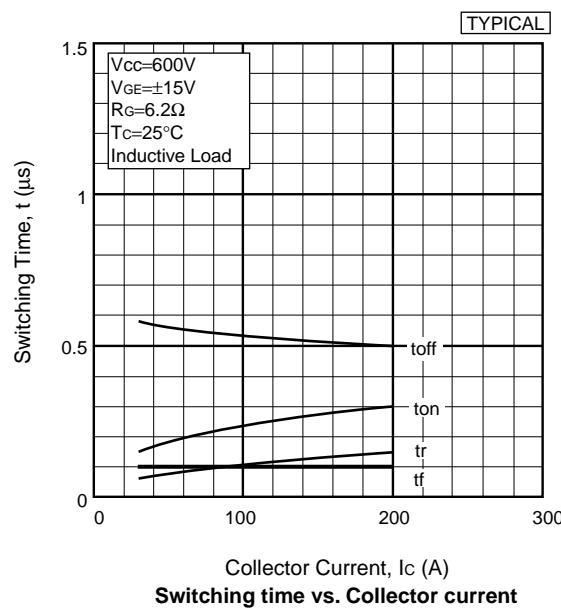
*2, *3 : Recommended value 1.67 N·m

CHARACTERISTICS ($T_C=25^\circ\text{C}$)

Item	Symbol	Unit	Min.	Typ.	Max.	Test Conditions
Collector-Emitter Cut-Off Current	I_{CES}	mA	—	—	1.0	$V_{CE}=1200\text{V}$, $V_{GE}=0\text{V}$
Gate-Emitter Leakage Current	I_{GES}	nA	—	—	± 500	$V_{GE}=\pm 20\text{V}$, $V_{CE}=0\text{V}$
Collector-Emitter Saturation Voltage	$V_{CE(\text{sat})}$	V	—	2.2	2.8	$I_C=200\text{A}$, $V_{GE}=15\text{V}$
Gate-Emitter Threshold Voltage	$V_{GE(\text{TO})}$	V	—	—	10	$V_{CE}=5\text{V}$, $I_C=200\text{mA}$
Input Capacitance	C_{ies}	pF	—	18000	—	$V_{CE}=10\text{V}$, $V_{GE}=0\text{V}$, $f=1\text{MHz}$
Switching Times	Rise Time	t_r	μs	—	0.15	0.3
	Turn-On Time	t_{on}		—	0.3	0.6
	Fall Time	t_f		—	0.1	0.3
	Turn-Off Time	t_{off}		—	0.5	1.0
Reverse Recovery Time	t_{rr}	μs	—	0.2	0.4	$V_{CC}=600\text{V}$, $I_C=200\text{A}$ $R_G=6.2\Omega$ $V_{GE}=\pm 15\text{V}$ Inductive Load $I_F=200\text{A}$
Peak Forward Voltage Drop	V_{FM}	V	—	2.5	3.5	
Thermal Impedance	IGBT	$R_{th(j-c)}$	$^\circ\text{C/W}$	—	—	
	FWD	$R_{th(j-c)}$		—	—	Junction to case
Notes: *4 : R_G value is the test condition's value for decision of the switching times, not recommended value, please determine the suitable R_G value after the measurement of switching waveforms (overshoot voltage, etc.) with appliance mounted.						

Remark: For actual application, please confirm this spec.sheet is the newest revision.





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